

PATENT
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B2 [0033.1] FIG. 8 is a cross-section of a portion of a cooling channel in an alternate PCB embodiment, in which the transistor die 202 is directly attached to the PCB with a surface of the die 202 forming a portion of the cooling channel 344.

In the Drawings:

Please insert Figure 8 required by Notice of Allowance, and supported by original claims 10 and 22.